



AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions and listings of claims in the application:

LISTING OF CLAIMS:

1. (currently amended): A film consisting of Aa polymer composition comprising a polymer having a glass transition temperature of 120°C to 400°C as a simple substance of the polymer and an organic modified layered silicate having a decomposition starting temperature of 250°C to 350°C wherein the organic modified layered silicate is contained in the polymer.

2. (currently amended): The ~~polymer composition~~film according to claim 1, wherein the polymer has a glass transition temperature of 160°C to 300°C.

3. (currently amended): The ~~polymer composition~~film according to claim 1, wherein the polymer has a glass transition temperature of 180°C to 250°C.

4. (currently amended): The ~~polymer composition~~film according to claim 1, wherein the polymer is selected from the group consisting of polycarbonates, cycloolefin polymers, polyalylates, polyether sulphones and olefin metathesis polymers.

5. (currently amended): The ~~polymer composition~~film according to claim 1, wherein the polymer is an olefin metathesis polymer.

6. (currently amended): The ~~polymer composition~~film according to claim 5, wherein the olefin metathesis polymer is prepared by olefin metathesis reaction of a norbornene type monomer.

7. (currently amended): The ~~polymer composition~~film according to claim 5, wherein the olefin metathesis polymer is prepared by olefin metathesis reaction of a monocyclic cycloolefin type monomer.

8. (cancelled)

9. (currently amended): The ~~polymer composition~~film according to claim 1, wherein the organic modified layered silicate has a decomposition starting temperature of 250°C to 300°C.

10. (currently amended): The ~~polymer composition~~film according to claim 1, wherein the organic modified layered silicate contains a compound selected from the group consisting of tetraalkylphosphonium compounds, triphenylphosphonium compounds, tetraphenylphosphonium compounds, and quaternary salts of nitrogen-containing heterocyclic compounds.

11. (currently amended): The ~~polymer composition~~film according to claim 1, wherein the organic modified layered silicate contains a tetraphenylphosphonium compound.

12. (currently amended): The ~~polymer composition film~~ according to claim 1, wherein the organic modified layered silicate contains a quaternary salt of nitrogen-containing or heterocyclic compound.

Claim 13. (canceled).

14. (currently amended): A gas barrier film comprising ~~the~~ film consisting of ~~the~~ polymer composition ~~according to claim 1~~comprising a polymer having a glass transition temperature of 120°C to 400°C as a simple substance of the polymer and an organic modified layered silicate having a decomposition starting temperature of 250°C to 350°C wherein the organic modified layered silicate is contained in the polymer and an organic/inorganic hybrid layer wherein the organic/inorganic hybrid layer is formed on the film by the sol-gel method.

15. (original): The gas barrier film according to claim 14, which further has a film comprising a polymer on the organic/inorganic hybrid layer.

16. (currently amended): The gas barrier film according to claim 15, wherein the film comprising a polymer consists of ~~the~~ polymer composition ~~according to claim 1~~comprising a polymer having a glass transition temperature of 120°C to 400°C as a simple substance of the

polymer and an organic modified layered silicate having a decomposition starting temperature of 250°C to 350°C wherein the organic modified layered silicate is contained in the polymer.

17. (original): The gas barrier film according to claim 15, which shows a gaseous oxygen transmission rate of 10 ml/m²•day•atm or less at 23°C, 90% RH.

18. (currently amended): A substrate comprising the film according to claim 131.

19. (currently amended): An image display device comprising the film according to claim 131.

20. (previously presented): The image display device according to claim 19, wherein the device is an organic EL device.